<table>
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<tr>
<th>ALL NORMS VALUES FOR TOP SIDE</th>
<th>BOARD 1</th>
<th>BOARD 2</th>
<th>BOARD 3</th>
<th>BOARD 4</th>
<th>BOARD 5</th>
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<tbody>
<tr>
<td>UPPER NIXE =</td>
<td>Bottom Drawing</td>
<td></td>
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<tr>
<td>LOWER NIXE =</td>
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<td>11-12-2023</td>
<td>33761-11</td>
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<td>TECO MATERIEST</td>
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